

H5N2515P

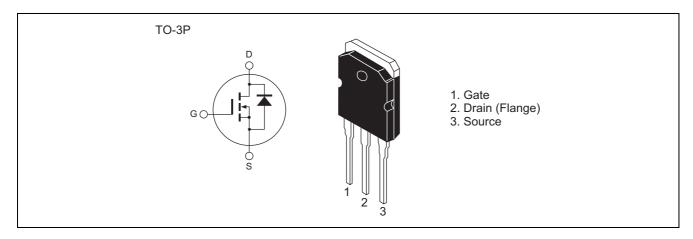
Silicon N Channel MOS FET High Speed Power Switching

REJ03G0413-0100 Rev.1.00 Sep.28.2004

Features

- Low on-resistance
- Low leakage current
- High speed switching

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to Source voltage	V _{DSS}	250	V
Gate to Source voltage	V_{GSS}	±30	V
Drain current	I _D	55	Α
Drain peak current	I _{D (pulse)} Note1	165	Α
Body-Drain diode reverse Drain current	I _{DR}	55	Α
Body-Drain diode reverse Drain peak current	I _{DR (pulse)} Note1	165	Α
Avalanche current	I _{AP} Note3	19	Α
Avalanche energy	E _{AR} Note3	22.5	mJ
Channel dissipation	Pch Note2	200	W
Channel to case thermal impedance	θch-c	0.625	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at Tc = 25°C

3. STch = 25° C, Tch $\leq 150^{\circ}$ C

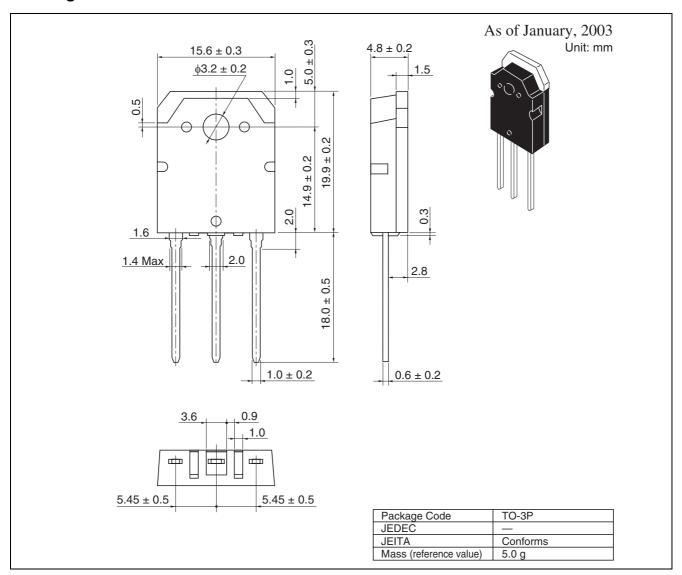
Electrical Characteristics

 $(Ta = 25^{\circ}C)$

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to Source breakdown voltage	$V_{(BR)DSS}$	250	_		V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Zero Gate voltage Drain current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 250 \text{ V}, V_{GS} = 0$
Gate to Source leak current	I _{GSS}		_	±0.1	μΑ	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0$
Gate to Source cutoff voltage	$V_{GS(off)}$	3.0	_	4.5	V	$V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$
Forward transfer admittance	yfs	23	39		S	$I_D = 27.5 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$
Static Drain to Source on state	R _{DS(on)}	_	0.039	0.044	Ω	$I_D = 27.5 \text{ A}, V_{GS} = 10 \text{ V}^{Note4}$
resistance						
Input capacitance	Ciss		3800		pF	V _{DS} = 25 V
Output capacitance	Coss	_	530	_	pF	V _{GS} = 0 f = 1 MHz
Reverse transfer capacitance	Crss	_	56	_	pF	
Turn-on delay time	t _{d(on)}		50		ns	I _D = 27.5 A
Rise time	t _r		240	_	ns	V _{GS} = 10 V
Turn-off delay time	t _{d(off)}	_	170	_	ns	$R_L = 4.55 \Omega$
Fall time	t _f	_	170	_	ns	$Rg = 10 \Omega$
Total Gate charge	Qg	_	92	_	nC	V _{DD} = 200 V
Gate to Source charge	Qgs	_	24	_	nC	V _{GS} = 10 V I _D = 55 A
Gate to Drain charge	Qgd	_	38	_	nC	
Body-Drain diode forward voltage	V_{DF}	_	1.03	1.60	V	$I_F = 55 \text{ A}, V_{GS} = 0^{\text{Note4}}$
Body-Drain diode reverse recovery time	trr	_	200	_	ns	I _F = 55 A, V _{GS} = 0
Body-Drain diode reverse recovery	Qrr	_	1.4	_	μС	diF/dt = 100 A/μs
charge						

Notes: 4. Pulse test

Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
H5N2515P-E	30 pcs	Plastic magazine

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